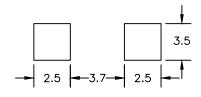
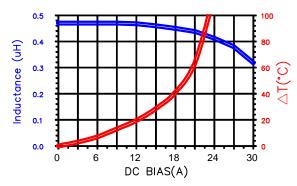
MGV0603R47M-10

PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	±	0.30
С	3.00	±	0.30
D	2.90	±	0.30
Ε	1.60	<u>±</u>	0.50

LAND PATTERNS FOR REFLOW SOLDERING

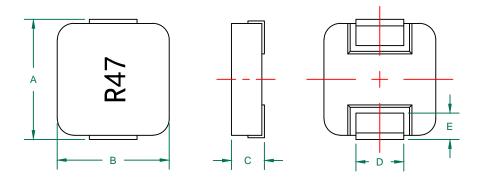




ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max	
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	0.376	0.470	0.564	
DCR (Ω)			0.0042	

Saturation Current ³ Isat (A)	26.00
Temperature Rise Current Irms ⁴ (A)	17.50







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2. OPERATION TEMPERATURE RANGE:
 -40°C~+125°C (INCLUDING SELF-HEATING) .
- 3. DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS APPROXIMATELY 25% FROM ITS VALUE WITHOUT CURRENT ($Ta=25\pm5$ °C).
- 4. DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE (\triangle T \leq 40°C) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm.			This print is the property of Lair					
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				reserved.				
D	CHANGE NOTE 3	04/22/15	QIU	PROJECT/PART NUMBER:		PART TY	-	DRAWN BY:
С	CHANGE NOTE 2.3.4	09/24/12	QIU	MGV0603R47M-10	D	INDU	WER CTOR	QIU
В	REVISE DIMENSIONS	06/27/12	QIU	DATE: 06/27/12	CALE: N	TS	SHEET:	
Α	ORIGINAL DRAFT	06/27/12	QIU		00L #	13		
REV	DESCRIPTION	DATE	INT	MGV0603R47M-10-D		-	1	of 1